

Data sheet

E-Duplexer Small cell LTE band 8

Series/type: D7905

Ordering code: B39941D7905D310

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Table of contents

1 Application	
2 <u>Features</u>	
3 Package	Ę
4 Pin configuration	6
5 Matching circuit.	
6 Characteristics.	
7 Maximum ratings	
8 Transmission coefficients	
9 Reflection coefficients	
10 <u>EVMs</u>	19
11 Packing material	21
12 Marking	
13 Soldering profile	
14 Annotations.	
15 Cautions and warnings	
16 Important notes	29



1 Application

- Enhanced Duplexer for LTE small cell systems (Band 8)
- High isolation > 60 dB min
- Usable pass band 35 MHz
- Low VSWR
- RX = uplink = 880 915 MHz
- TX = downlink = 925 960 MHz

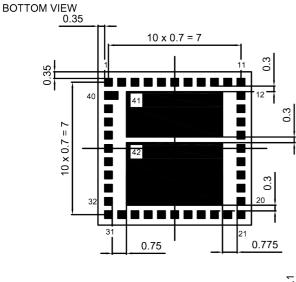
2 Features

- Package size 8.1±0.1 mm × 8.1±0.1 mm
- Package height 1.1 mm (max.)
- Approximate weight 0.2 g
- RoHS compatible
- Package for Surface Mount Technology (SMT)
- Ni/Au-plated terminals
- Electrostatic Sensitive Device (ESD)
- Moisture Sensitivity Level 3 (MSL3)

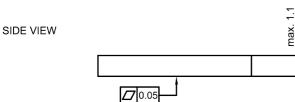


Figure 1: Picture of component with example of product marking.

3 Package



Pad sizes: Pad 1-39: 0.40 x 0.40 mm² Pad 40: 0.70 x 0.40 mm² Pad 41: 5.075 x 2.395 mm² Pad 42: 5.075 x 3.305 mm² Pad tolerance ±0.05



8.1±0.1

31

XXXX

XXX

1)

40

11

40

5)

32

12

40

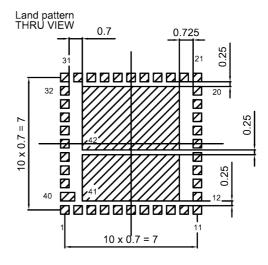
11

4)

5)

3)

2)



- 6) Tracking ID (5 8 digits)
- 5) Indicating production site C=Wxi)
- 4) Marking for pad number
- 3) Date code acc. EPCOS (day)
- 2) Date code acc. to EN60062 (year, month)
- 1) Position for type designation

Landing pad sizes: Pad 1-39: 0.45 x 0.45 mm² Pad 40: 0.70 x 0.40 mm² Pad 41: 5.125 x 2.445 mm² Pad 42: 5.125 x 3.355 mm² Landing pad tolerance -0.02

Figure 2: Drawing of package with package height A = 1.1 mm (max.). See Sec. Package information (p. 28).



4 Pin configuration

- 3 TX
- 13 RX
- 29 ANT
- 1, 2, 4, 5, Ground
 - 6, 7, 8, 9,
 - 10, 11,
 - 12, 14,
 - 15, 16,
 - 17, 18,
 - 19, 20,
 - 21, 22,
 - 23, 24,
 - 25, 26,
 - 27, 28,
 - 30, 31,
 - 32, 33,
 - 34, 35,
 - 36, 37,
 - 38, 39,
 - 40, 41, 42

5 Matching circuit

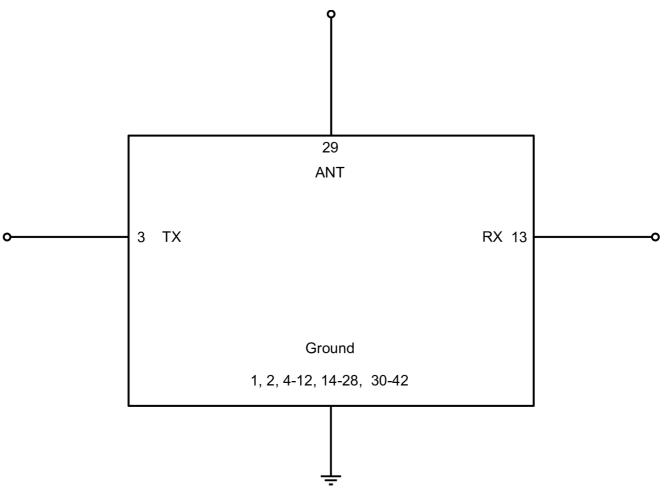


Figure 3: Schematic of matching circuit. No external matching components required.



6 Characteristics

6.1 TX - ANT

Temperature range for specification $T_{\text{SPEC}} = -10 \,^{\circ}\text{C} \dots +85 \,^{\circ}\text{C}$

TX terminating impedance $Z_{\rm TX} = 50~\Omega$ ANT terminating impedance $Z_{\rm ANT} = 50~\Omega$ RX terminating impedance $Z_{\rm RX} = 50~\Omega$

Characteristics TX – ANT				$\begin{array}{c} \text{min.} \\ \text{for } T_{\text{SPEC}} \end{array}$	typ. @ +25 °C	$\begin{array}{c} \text{max.} \\ \text{for } T_{\text{SPEC}} \end{array}$	
Center frequency			f _C	_	942.5	_	MHz
Average insertion attenuation			$\alpha_{\text{INT,avg}}^{\qquad 1)}$				
	925 930	MHz	, ,	_	2.2	3.0	dB
	930 955	MHz		_	1.8	2.8	dB
	955 960	MHz		_	1.8	3.0	dB
Maximum insertion attenuation			α_{max}				
	925.24 959.76	MHz		_	2.5	4.0	dB
Amplitude ripple (p-p)			Δα				
	925.24 959.76	MHz		_	1.1	2.3	dB
Maximum VSWR			$VSWR_{max}$				
@ TX port	925.24 959.76	MHz		_	1.2	1.7	
@ ANT port	925.24 959.76	MHz		_	1.2	1.7	
Maximum error vector magnitude			$EVM_{max}^{}2)}$				
	927.4 957.6	MHz		_	2.9	5.7	%
	927.74 957.26	MHz		_	2.6	4.9	%
Minimum attenuation			$\boldsymbol{\alpha}_{min}$				
	10 791	MHz		35	39	_	dB
	791 821	MHz		35	40	_	dB
	832 862	MHz		35	43	_	dB
	880.24 914.76	MHz		45	53	_	dB
	1570 1606	MHz		40	53	_	dB
	1710 1785	MHz		40	54	_	dB
	1805 1880	MHz		40	59	_	dB
	1920 1980	MHz		40	61	_	dB
	2110 2200	MHz		40	55	_	dB
	2400 2500	MHz		40	53	_	dB
	2500 2570	MHz		40	57	_	dB
	2620 2690	MHz		40	60	_	dB
	3400 3800	MHz		30	43	_	dB
	3800 5150	MHz		30	44	_	dB
	5150 5850	MHz		30	50		dB

Integrated attenuation α_{INT} : Averaged power $|S_{ij}|^2$ over the center 4.5 MHz of LTE 5 MHz (25 RB) channels.

²⁾ Error Vector Magnitude (EVM) based on definition in 3GPP TS 25.141.



Temperature range for specification $T_{\text{SPEC}} = -40 \,^{\circ}\text{C} \dots +95 \,^{\circ}\text{C}$

TX terminating impedance $Z_{\text{TX}} = 50 \ \Omega$ ANT terminating impedance $Z_{\text{ANT}} = 50 \ \Omega$ RX terminating impedance $Z_{\text{RX}} = 50 \ \Omega$

Characteristics TX – ANT				$\begin{array}{c} \textbf{min.} \\ \textbf{for } T_{\texttt{SPEC}} \end{array}$	typ. @ +25 °C	$\begin{array}{c} \text{max.} \\ \text{for } T_{\text{SPEC}} \end{array}$	
Average insertion attenuation			α _{INT,avg} 1)				
	925 930	MHz		_	2.3	3.2	dB
	930 955	MHz		_	1.9	2.8	dB
	955 960	MHz		_	1.9	3.0	dB
Maximum insertion attenuation			α_{max}				
	925.24 959.76	MHz		_	2.5	4.4	dB
Amplitude ripple (p-p)			Δα				
	925.24 959.76	MHz		_	1.1	3.2	dB
Maximum VSWR			$VSWR_{max}$				
@ TX port	925.24 959.76	MHz		_	1.2	1.7	
@ ANT port	925.24 959.76	MHz		_	1.2	1.7	
Maximum error vector magnitude			EVM _{max} ²⁾				
	927.4 957.6	MHz		_	2.9	7.5	%
Minimum attenuation			$\alpha_{_{min}}$				
	10 791	MHz		35	40	_	dB
	791 821	MHz		35	40	_	dB
	832 862	MHz		35	43	_	dB
	880.24 914.76	MHz		40	53	_	dB
	1570 1606	MHz		40	53	_	dB
	1710 1785	MHz		40	54	_	dB
	1805 1880	MHz		40	59	_	dB
	1920 1980	MHz		40	61	_	dB
	2110 2200	MHz		40	55	_	dB
	2400 2500	MHz		40	53	_	dB
	2500 2570	MHz		40	57	_	dB
	2620 2690	MHz		40	60	_	dB
	3400 3800	MHz		30	43	_	dB
	3800 5150	MHz		30	44	_	dB
	5150 5850	MHz		30	50	_	dB

¹⁾ Integrated attenuation $\alpha_{_{INT}}$: Averaged power $|S_{_{ii}}|^2$ over the center 4.5 MHz of LTE 5 MHz (25 RB) channels.

²⁾ Error Vector Magnitude (EVM) based on definition in 3GPP TS 25.141.



6.2 ANT - RX

Temperature range for specification $T_{\text{SPEC}} = -10 \,^{\circ}\text{C} \dots +85 \,^{\circ}\text{C}$

TX terminating impedance $Z_{\rm TX} = 50~\Omega$ ANT terminating impedance $Z_{\rm ANT} = 50~\Omega$ RX terminating impedance $Z_{\rm RX} = 50~\Omega$

Characteristics ANT – RX				$\begin{array}{c} \textbf{min.} \\ \textbf{for } T_{\texttt{SPEC}} \end{array}$	typ. @ +25 °C	$\begin{array}{c} \text{max.} \\ \text{for } T_{\text{SPEC}} \end{array}$	
Center frequency			f _C	_	897.5	_	MHz
Average insertion attenuation			$\alpha_{\text{INT,avg}}^{\qquad 1)}$				
	880 885	MHz	, ,	_	2.0	2.8	dB
	885 910	MHz		_	1.8	2.8	dB
	910 915	MHz		_	2.1	3.2	dB
Maximum insertion attenuation			$\boldsymbol{\alpha}_{\text{max}}$				
	880.24 914.76	MHz		_	2.2	4.0	dB
Amplitude ripple (p-p)			Δα				
	880.24 914.76	MHz		_	0.8	2.0	dB
Maximum VSWR			$VSWR_{max}$				
@ ANT port	880.24 914.76	MHz		_	1.2	1.7	
@ RX port	880.24 914.76	MHz		_	1.2	1.7	
Maximum error vector magnitude			EVM _{max} ²⁾				
	882.4 912.6	MHz		_	2.8	5.3	%
	882.74 912.26	MHz		_	2.7	4.7	%
Minimum attenuation			$\boldsymbol{\alpha}_{\text{min}}$				
	10 791	MHz		35	40	_	dB
	791 821	MHz		35	42	_	dB
	832 862	MHz		30	48	_	dB
	925.24 959.76	MHz		45	53	_	dB
	1710 1785	MHz		40	58	_	dB
	1805 1880	MHz		40	60	_	dB
	1920 1980	MHz		40	59	_	dB
	2110 2200	MHz		40	53	_	dB
	2400 2500	MHz		40	52	_	dB
	2500 2570	MHz		40	54	_	dB
	2620 2690	MHz		40	54	_	dB
	2690 3400	MHz		35	43	_	dB
	3400 3800	MHz		30	41	_	dB
	3800 5150	MHz		25	37	_	dB
	5150 5850	MHz		25	39	_	dB

Integrated attenuation α_{INT} : Averaged power $|S_{ij}|^2$ over the center 4.5 MHz of LTE 5 MHz (25 RB) channels.

²⁾ Error Vector Magnitude (EVM) based on definition in 3GPP TS 25.141.



Temperature range for specification $T_{\text{SPEC}} = -40 \,^{\circ}\text{C} \dots +95 \,^{\circ}\text{C}$

TX terminating impedance $Z_{\text{TX}} = 50 \ \Omega$ ANT terminating impedance $Z_{\text{ANT}} = 50 \ \Omega$ RX terminating impedance $Z_{\text{RX}} = 50 \ \Omega$

Characteristics ANT – RX				$\begin{array}{c} \text{min.} \\ \text{for } T_{\text{SPEC}} \end{array}$	typ. @ +25 °C	$\begin{array}{c} \text{max.} \\ \text{for } T_{\text{SPEC}} \end{array}$	
Average insertion attenuation			α _{INT,avg} 1)				
	880 885	MHz	-	_	2.1	3.0	dB
	885 910	MHz		_	1.8	2.8	dB
	910 915	MHz		_	2.1	3.2	dB
Maximum insertion attenuation			α_{max}				
	880.24 914.76	MHz		_	2.2	4.3	dB
Amplitude ripple (p-p)			Δα				
	880.24 914.76	MHz		_	0.8	2.5	dB
Maximum VSWR			$VSWR_{max}$				
@ ANT port	880.24 914.76	MHz		_	1.2	1.7	
@ RX port	880.24 914.76	MHz		_	1.2	1.7	
Maximum error vector magnitude			$EVM_{max}^{}}$				
	882.4 912.6	MHz		_	2.8	5.8	%
Minimum attenuation			$\boldsymbol{\alpha}_{_{min}}$				
	10 791	MHz		35	40	<u> </u>	dB
	791 821	MHz		35	42	<u> </u>	dB
	832 862	MHz		30	48	_	dB
	925.24 959.76	MHz		38	53	_	dB
	1710 1785	MHz		40	58	_	dB
	1805 1880	MHz		40	60	_	dB
	1920 1980	MHz		40	59	<u> </u>	dB
	2110 2200	MHz		40	53	<u> </u>	dB
	2400 2500	MHz		40	53	_	dB
	2500 2570	MHz		40	52	_	dB
	2620 2690	MHz		40	54	_	dB
	2690 3400	MHz		35	43	_	dB
	3400 3800	MHz		30	41	_	dB
	3800 5150	MHz		25	37	_	dB
	5150 5850	MHz		25	39	_	dB

Integrated attenuation α_{INT} : Averaged power $|S_{ij}|^2$ over the center 4.5 MHz of LTE 5 MHz (25 RB) channels.

²⁾ Error Vector Magnitude (EVM) based on definition in 3GPP TS 25.141.



6.3 TX - RX

Temperature range for specification $T_{\text{SPEC}} = -10 \,^{\circ}\text{C} \dots +85 \,^{\circ}\text{C}$

TX terminating impedance $Z_{\rm TX} = 50~\Omega$ ANT terminating impedance $Z_{\rm ANT} = 50~\Omega$ RX terminating impedance $Z_{\rm RX} = 50~\Omega$

Characteristics TX – RX				$\begin{array}{c} \text{min.} \\ \text{for } T_{\text{SPEC}} \end{array}$	typ. @ +25 °C	$\begin{array}{c} \text{max.} \\ \text{for } T_{\text{SPEC}} \end{array}$	
Average isolation			α _{INT,avg} 1)				
	880.24 914.76	MHz		63	72	_	dB
	925.24 959.76	MHz		63	78	_	dB
Minimum isolation			$\boldsymbol{\alpha}_{\text{min}}$				
	880.24 914.76	MHz		60	71	_	dB
	925.24 959.76	MHz		60	75	_	dB

Integrated attenuation $\alpha_{_{INT}}$: Averaged power $|S_{_{IJ}}|^2$ over the center 4.5 MHz of LTE 5 MHz (25 RB) channels.



Temperature range for specification $T_{\text{SPEC}} = -40 \,^{\circ}\text{C} \dots +95 \,^{\circ}\text{C}$

TX terminating impedance $Z_{\rm TX} = 50~\Omega$ ANT terminating impedance $Z_{\rm ANT} = 50~\Omega$ RX terminating impedance $Z_{\rm RX} = 50~\Omega$

Characteristics TX – RX					typ. @ +25 °C	$\begin{array}{c c} \mathbf{max.} \\ \mathbf{for} \ T_{\mathtt{SPEC}} \end{array}$	
Average isolation			α _{INT,avg} 1)				
	880.24 914.76	MHz		63	72	_	dB
	925.24 959.76	MHz		63	78	_	dB
Minimum isolation			$\boldsymbol{\alpha}_{\text{min}}$				
	880.24 914.76	MHz		60 ²⁾	71	_	dB
	880.24 914.76	MHz		53	71	_	dB
	925.24 959.76	MHz		60	75	_	dB

Integrated attenuation $\alpha_{_{|NT}}$: Averaged power $|S_{_{||}}|^2$ over the center 4.5 MHz of LTE 5 MHz (25 RB) channels.

²⁾ Valid for temperature $T = -40 \,^{\circ}\text{C...} + 85 \,^{\circ}\text{C.}$



7 **Maximum ratings**

Operable temperature	T _{OP} = -40 °C +95 °C	
Storage temperature	T _{STG} ¹⁾ = −40 °C +95 °C	
DC voltage	$ V_{DC} ^{2)} = 0 \text{ V (max.)}$	
ESD voltage		
	$V_{ESD}^{3)} = 100 \text{ V (max.)}$	Machine model.
	$V_{ESD}^{4)} = 100 \text{ V (max.)}$	Human body model.
Input power	P _{IN}	
@ TX port: 925.24 959.76 MHz	31 dBm ⁵⁾	5 MHz LTE downlink signal for 100000 h @ 55 °C. P _{IN}
		average – 42 dBm peak. Source and load impedance 50 Ω.
@ TX port: other frequency ranges	10 dBm	Source and load impedance 50 Ω .

Not valid for packaging material. Storage temperature for packaging material is -25 °C to +40 °C.

²⁾

³⁾

In case of applied DC voltage blocking capacitors are mandatory.

According to JESD22-A115B (MM – Machine Model), 10 negative & 10 positive pulses.

According to JESD22-A114F (HBM – Human Body Model), 1 negative & 1 positive pulses. 4)

Expected lifetime according to accelerated power durability test and wear out models.

8 Transmission coefficients

8.1 TX - ANT 0.0 $-\alpha/dB$ 2.0 1.964 2/608 4.0 910 920 930 950 960 970 940 $f/{\sf MHz}$ 0.0 20.0 40.0 60.0 80.0 1050 800 850 1000 900 950 1100 f/MHz 0.0 20.0 40.0 60.0 80.0 4000 1000 2000 3000 5000 6000 f/MHz

Figure 4: Attenuation TX – ANT.

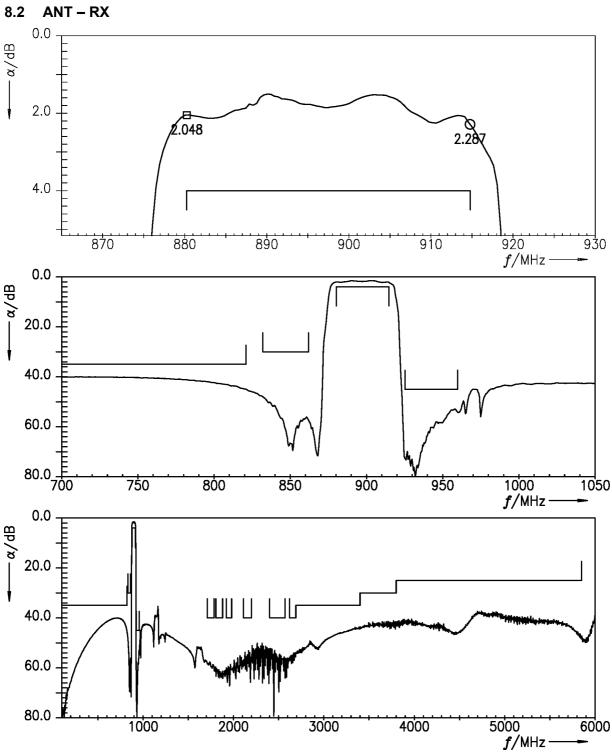


Figure 5: Attenuation ANT – RX.

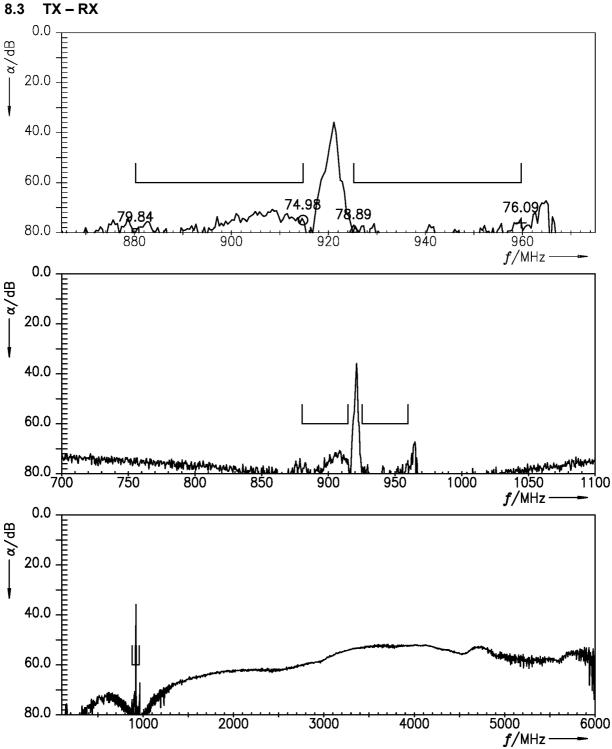
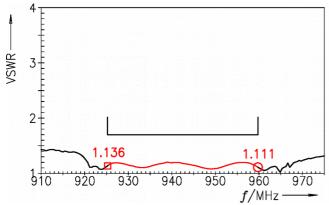


Figure 6: Isolation TX – RX.

9 Reflection coefficients



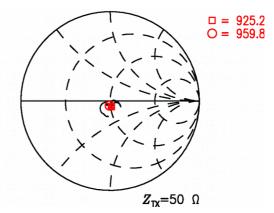
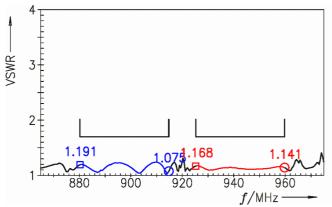


Figure 7: Reflection coefficient at TX port.



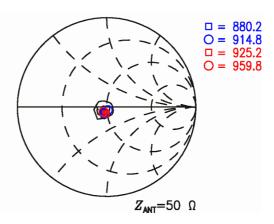
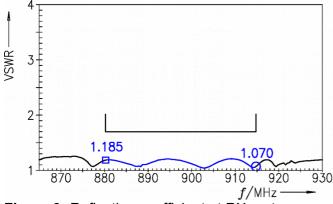


Figure 8: Reflection coefficient at ANT port.



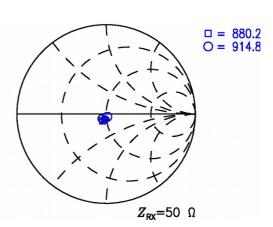


Figure 9: Reflection coefficient at RX port.

10 EVMs

10.1 TX - ANT

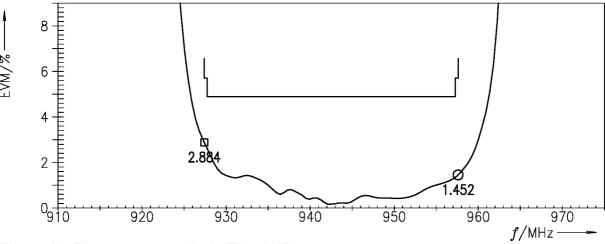


Figure 10: Error vector magnitude TX – ANT.

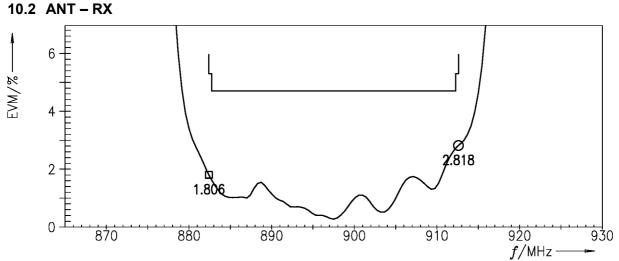


Figure 11: Error vector magnitude ANT – RX.

11 Packing material

11.1 Tape

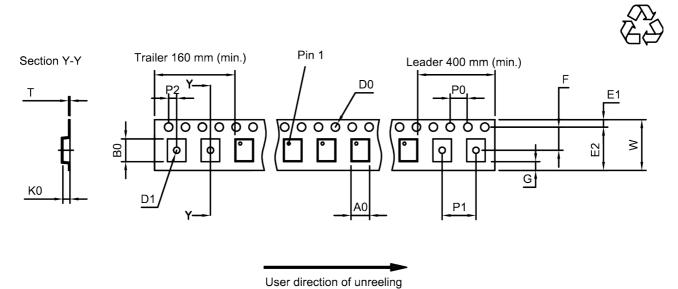


Figure 12: Drawing of tape (first-angle projection) with tape dimensions according to Table 1.

A_0	8.4±0.05 mm	E ₂	14.25 mm (min.)		P ₁	12.0±0.1 mm
B ₀	8.4±0.05 mm	F	7.5±0.1 mm		P_2	2.0±0.1 mm
D ₀	1.5+0.1/-0 mm	G	0.75 mm (min.)		Т	0.3±0.05 mm
D_1	1.5 mm (min.)	K ₀	1.3±0.1 mm		W	16.0+0.3/-0.1 mm
E ₁	1.75 _{±0.1} mm	P ₀	4.0±0.1 mm	_		

Table 1: Tape dimensions.

11.2 Reel with diameter of 330 mm

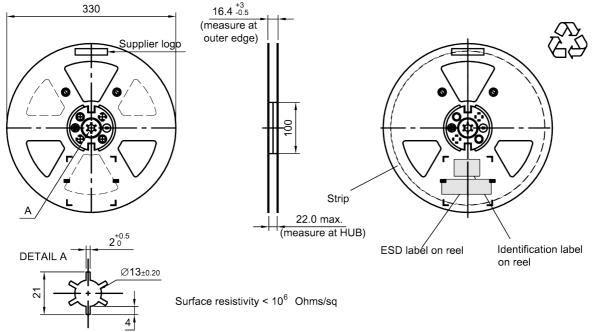


Figure 13: Drawing of reel (first-angle projection) with diameter of 330 mm.

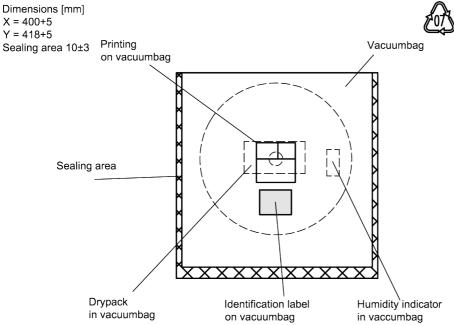


Figure 14: Drawing of moisture barrier bag (MBB) for reel with diameter of 330 mm.

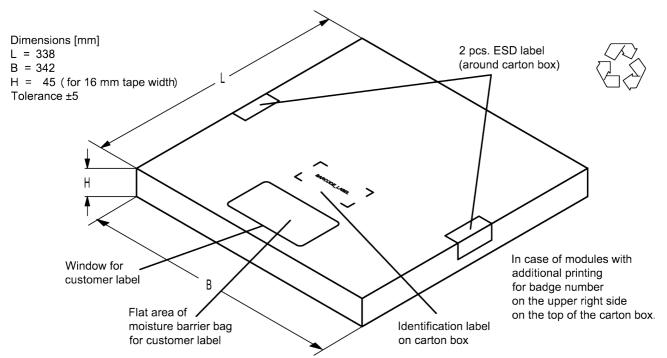


Figure 15: Drawing of folding box for reel with diameter of 330 mm.

12 Marking

Products are marked with tracking number (5 or 8 characters), type designator (5 characters), as well as production location and date code (4 characters). The marking corresponds to one of the following schemes:

XXXXX	5-character tracking number
XXXXX	5-character type designator
M5C6	1-character location code + 3-character date code (example)

Table 2: Marking for 5-character tracking number (standard).

XXXXXXXX	8-character tracking number
XXXXX	5-character type designator
M5C6	1-character location code + 3-character date code (example)

Table 3: Marking for 8-character tracking number.

???	
XXXXXXXX	8-character tracking number
XXXXX	5-character type designator
M5C6	1-character location code + 3-character date code (example)

Table 4: Marking for 8-character tracking number with 4 lines.

■ Tracking number: t.b.d.

■ Type designator: The 5-character type designator of the ordering code is used for the marking.

Example: B3xxxx**D1234**xxxx

■ Production-location and date code: The production-location is encoded in the first character according to Table 5. The production date code is encoded in the last three characters according to Table 6.

Code:	M or no letter	J	С	Н		
Location:	Munich	Singapore	Wuxi	SAE, Hong Kong		

Table 5: Production location code.



1 st digit (day)			2 nd digit (year)			3 rd digit (month)							
Day	Code	Day	Code	Day	Code	Year	Code	Year	Code	Month	Code	Month	Code
1	1	11	Α	21	М	2010	Α	2022	Р	Jan	1	Jul	7
2	2	12	В	22	N	2011	В	2023	R	Feb	2	Aug	8
3	3	13	С	23	Р	2012	С	2024	S	Mar	3	Sep	9
4	4	14	D	24	R	2013	D	2025	Т	Apr	4	Oct	0
5	5	15	E	25	S	2014	E	2026	U	May	5	Nov	N
6	6	16	F	26	Т	2015	F	2027	V	Jun	6	Dec	D
7	7	17	Н	27	U	2016	Н	2028	W				
8	8	18	J	28	V	2017	J	2029	Х				
9	9	19	K	29	W	2018	K	2030	Z				
10	0	20	L	30	Х	2019	L	2031	Α				
				31	Z	2020	М	2032	В				
						2021	N	and	so on				

Table 6: Production date code.

Example of how to decode production location and date code:

Code: M5C6



13 Soldering profile

The recommended soldering process is in accordance with IEC $60068-2-58-3^{rd}$ edit and IPC/JEDEC J-STD-020B.

ramp rate	≤ 3 K/s
preheat	125 °C to 220 °C, 150 s to 210 s, 0.4 K/s to 1.0 K/s
T > 220 °C	30 s to 70 s
T > 230 °C	min. 10 s
T > 245 °C	max. 20 s
<i>T</i> ≥ 255 °C	-
peak temperature T_{peak}	250 °C +0/-5 °C
wetting temperature T_{\min}	230 °C +5/-0 °C for 10 s ± 1 s
cooling rate	≤ 3 K/s
soldering temperature T	measured at solder pads

Table 7: Characteristics of recommended soldering profile for lead-free solder (Sn95.5Ag3.8Cu0.7).

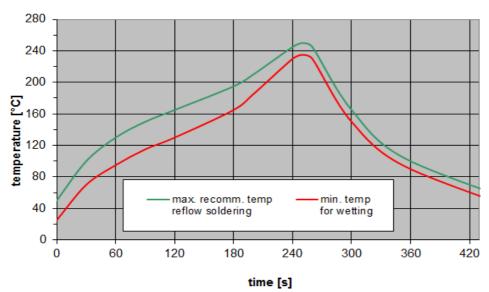


Figure 16: Recommended reflow profile for convection and infrared soldering – lead-free solder.

14 Annotations

14.1 Matching coils

See TDK inductor pdf-catalog http://www.tdk.co.jp/tefe02/coil.htm#aname1 and Data Library for circuit simulation http://www.tdk.co.jp/etvcl/index.htm.

14.2 RoHS compatibility

ROHS-compatible means that products are compatible with the requirements according to Art. 4 (substance restrictions) of Directive 2011/65/EU of the European Parliament and of the Council of June 8th, 2011, on the restriction of the use of certain hazardous substances in electrical and electronic equipment ("Directive") with due regard to the application of exemptions as per Annex III of the Directive in certain cases.

14.3 Scattering parameters (S-parameters)

The pin/port assignment is available in the headers of the S-parameter files. Please contact your local RF360 sales office.

14.4 Ordering codes and packing units

Ordering code	Packing unit
B39941D7905D310	3000 pcs

Table 8: Ordering codes and packing units.



15 Cautions and warnings

15.1 Display of ordering codes for RF360 products

The ordering code for one and the same product can be represented differently in data sheets, data books, other publications and the website of RF360, or in order-related documents such as shipping notes, order confirmations and product labels. The varying representations of the ordering codes are due to different processes employed and do not affect the specifications of the respective products. Detailed information can be found on the Internet under www.rf360jv.com/orderingcodes.

15.2 Material information

Due to technical requirements components may contain dangerous substances. For information on the type in question please also contact one of our sales offices.

For information on recycling of tapes and reels please contact one of our sales offices.

15.3 Moldability

Before using in overmolding environment, please contact your local RF360 sales office.

15.4 Package information

Landing area

The printed circuit board (PCB) land pattern (landing area) shown is based on RF360 internal development and empirical data and illustrated for example purposes, only. As customers' SMD assembly processes may have a plenty of variants and influence factors which are not under control or knowledge of RF360, additional careful process development on customer side is necessary and strongly recommended in order to achieve best soldering results tailored to the particular customer needs.

Dimensions

Unless otherwise specified all dimensions are understood using unit millimeter (mm).

Projection method

Unless otherwise specified first-angle projection is applied.



16 Important notes

The following applies to all products named in this publication:

- 1. Some parts of this publication contain statements about the suitability of our products for certain areas of application. These statements are based on our knowledge of typical requirements that are often placed on our products in the areas of application concerned. We nevertheless expressly point out that such statements cannot be regarded as binding statements about the suitability of our products for a particular customer application. As a rule, RF360 Europe GmbH and its affiliates are either unfamiliar with individual customer applications or less familiar with them than the customers themselves. For these reasons, it is always ultimately incumbent on the customer to check and decide whether an RF360 product with the properties described in the product specification is suitable for use in a particular customer application.
- 2. We also point out that in individual cases, a malfunction of electronic components or failure before the end of their usual service life cannot be completely ruled out in the current state of the art, even if they are operated as specified. In customer applications requiring a very high level of operational safety and especially in customer applications in which the malfunction or failure of an electronic component could endanger human life or health (e.g. in accident prevention or life-saving systems), it must therefore be ensured by means of suitable design of the customer application or other action taken by the customer (e.g. installation of protective circuitry or redundancy) that no injury or damage is sustained by third parties in the event of malfunction or failure of an electronic component.
- 3. The warnings, cautions and product-specific notes must be observed.
- 4. In order to satisfy certain technical requirements, some of the products described in this publication may contain substances subject to restrictions in certain jurisdictions (e.g. because they are classed as hazardous). Useful information on this will be found in our Material Data Sheets on the Internet (www.rf360jv.com/material). Should you have any more detailed questions, please contact our sales offices.
- 5. We constantly strive to improve our products. Consequently, the products described in this publication may change from time to time. The same is true of the corresponding product specifications. Please check therefore to what extent product descriptions and specifications contained in this publication are still applicable before or when you place an order. We also reserve the right to discontinue production and delivery of products. Consequently, we cannot guarantee that all products named in this publication will always be available.

The aforementioned does not apply in the case of individual agreements deviating from the foregoing for customer-specific products.